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102388625

Reference: 648.42552X00

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## 1. Name of conveying party(ies):

TRICKETT, DOUGLAS M.

FURUSE, MUNEO

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

## 2. Name and address of receiving party(ies)

Name: HITACHI HIGH-TECHNOLOGIES  
CORPORATION

Street Address: 1-24-14, Nishi Shimbashi, Minato-ku

City: Tokyo 105-8717

Country: Japan

## 3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other \_\_\_\_\_

Execution Date: February 12, 2003.

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## 4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: February 12, 2003.

A. Patent Application No.(s)

B. Patent Registration No.(s)

10376304

Additional number(s) attached ☐ Yes ☒ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Antonelli, Terry, Stout &amp; Kraus, LLP

Internal Address:

1300 North Seventeenth Street  
Suite 1800  
Arlington, VA 22209  
USA

City: State: Zip:

## 6. Total number of applications and patents involved 1

## 7. Total fee (37 CFR 3.41)..... \$40.00

☒ Enclosed☐ Authorized to be charged to deposit account

## 8. Deposit account number:

01-2135

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## 9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

William I. Solomon, Reg# 28,565

03/03/2003

Name of Person Signing

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Date

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PATENT  
REEL: 013827 FRAME: 0291

# ASSIGNMENT

( 譲 渡 証 )

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 1-24-14, Nishi Shimbashi, Minato-ku, Tokyo 105-8717, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

## METHOD FOR COATING INTERNAL SURFACE OF PLASMA PROCESSING CHAMBER

invented by me (if only one is named below ) or us (if plural inventors are named below ) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation.

Signed on the date(s) indicated aside signatures:

### INVENTOR(S)

(発明者フルネームサイン)

### Date Signed

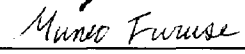
(署名日)

1) Douglas M. TRICKETT



February 12, 2003

2) Muneo FURUSE



12 / February / 2003

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